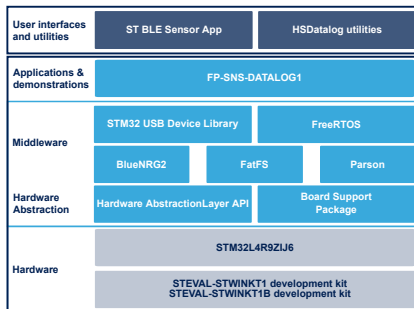


STM32Cube High Speed Datalog function pack for STWIN evaluation kits



Features

- High-rate (up to 6 Mbit/s) data capture software suite:
 - Bluetooth® low energy app for system setup and real-time control
 - Python and C++ real-time control applications
 - Dedicated Python SDK for sensor data analysis
 - Host developer's API enables integration into any data science design flow
 - Compatible with [Unico-GUI](#) which enables configuration of [ISM330DHCX](#) Machine Learning Core unit
 - Timestamping for sensor data synchronization
- Embedded software, middleware and drivers:
 - FatFS third-party FAT file system module for small embedded systems
 - FreeRTOS third-party RTOS kernel for embedded devices
 - STWIN low-level BSP drivers
- Based on [STM32Cube](#) software development environment for STM32 microcontrollers

Description

The [FP-SNS-DATALOG1](#) function pack implements High Speed Datalog application for [STEWAL-STWINKT1](#) and [STEWAL-STWINKT1B](#). It provides a comprehensive solution to save data from any combination of sensors and microphones configured up to the maximum sampling rate.

The application also allows configuring [ISM330DHCX](#) Machine Learning Core unit and reading its output.

Sensor data can be stored onto a micro SD card (Secure Digital High Capacity - SDHC) formatted with the FAT32 file system, or streamed to a PC via USB (WinUSB class) using the companion host software (`cli_example`) provided for Windows and Linux.

The [FP-SNS-DATALOG1](#) allows configuring the board via JSON file as well as starting and controlling data acquisition. Commands can be sent from a host via command line interface.

The application can be controlled via Bluetooth using the [STBLESensor](#) app (available for Android and under development for iOS) which lets you manage the board and sensor configurations, start/stop data acquisition on SD card, control data labelling and display the output of the Machine Learning Core.

To read sensor data acquired using [FP-SNS-DATALOG1](#), easy-to-use scripts in Python and Matlab are provided within the software package. The scripts have been successfully tested with MATLAB v2019a and Python 3.7.

Product summary	
STWIN SensorTile Wireless Industrial Node development kit	STEWAL-STWINKT1/STEWAL-STWINKT1B
High Speed Datalog function pack for STWIN evaluation kits	FP-SNS-DATALOG1
Firmware runs on:	STM32L4R9ZIJ6 Ultra-low-power ARM Cortex-M4 MCU with FPU
FW development environments	- Keil - IAR Embedded Workbench - STM32CubeIDE
Other utilities	STBLESensor mobile Android/iOS app for sensor data visualization
Applications	Condition Monitoring / Predictive Maintenance Sensing

1 Detailed description

1.1 What can you do with STM32Cube function packs?

STM32Cube function packs leverage the modularity and interoperability of STM32 Nucleo and X-NUCLEO boards together with STM32Cube and X-CUBE software to create function examples for some of the most common use cases of different application technologies.

These software function packs are designed to exploit the underlying STM32 ODE hardware and software components as much as possible to best satisfy the requirements of final user applications.

Moreover, function packs may include additional libraries and frameworks that are not present in the original X-CUBE packages, thus enabling new functionalities allowing real and usable system for developers.

1.2 What is STM32Cube?

STM32Cube is a combination of a full set of PC software tools and embedded software blocks running on STM32 microcontrollers and microprocessors:

- [STM32CubeMX](#) configuration tool for any STM32 device; it generates initialization C code for Cortex-M cores and the Linux device tree source for Cortex-A cores
- [STM32CubeIDE](#) integrated development environment based on open-source solutions like Eclipse or the GNU C/C++ toolchain, including compilation reporting features and advanced debug features
- [STM32CubeProgrammer](#) programming tool that provides an easy-to-use and efficient environment for reading, writing and verifying devices and external memories via a wide variety of available communication media (JTAG, SWD, UART, USB DFU, I2C, SPI, CAN, etc.)
- STM32CubeMonitor family of tools ([STM32CubeMonRF](#), [STM32CubeMonUCPD](#), [STM32CubeMonPwr](#)) to help developers customize their applications in real-time
- [STM32Cube MCU and MPU packages](#) specific to each STM32 series with drivers (HAL, low-layer, etc.), middleware, and lots of example code used in a wide variety of real-world use cases
- [STM32Cube expansion packages](#) for application-oriented solutions

1.3 How does this function pack complement STM32Cube?

This software is based on the STM32CubeHAL. It extends [STM32Cube](#) by providing a board support package (BSP) for the STWIN SensorTile Wireless Industrial Node evaluation kits.

The drivers abstract low-level details of the hardware and allow the middleware components and applications to access data in a hardware-independent manner.

The package includes some middleware libraries to store data onto a micro SD card (through third-party FatFS module) and stream data to a PC via USB (thanks to the SensorStreaming WCID USB class).

The application also takes advantage of the FreeRTOS module, thus enabling a real-time operating system into an STM32 microcontroller.

To enable Bluetooth® low energy communication, the package exploits also the capabilities of [BlueNRG-2](#) middleware.

Revision history

Table 1. Document revision history

Date	Version	Changes
10-Nov-2020	1	Initial release.
15-Dec-2020	2	Updated cover page features and Section 1.3 How does this function pack complement STM32Cube?.

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